International Conference on Machine Learning and Data Engineering

Preface

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We are pleased to present this special issue of Elsevier's Procedia Computer Science Journal, which consists of the proceedings of the international conference on Machine Learning and Data Engineering (ICMLDE 2022).

The ICMLDE 2022 received more than one thousand manuscripts worldwide including Algeria, Bangladesh, China, Czechia, Eswatini, Ethiopia, Finland, France, India, Iran, Iraq, Ireland, Italy, Jordan, Korea, The Democratic People's Republic of Malaysia, Morocco, Nigeria, Norway, Oman, Peru, Philippines, Saudi Arabia, Slovakia, South Korea, Spain, Sri Lanka, Switzerland, Turkey, United Arab Emirates, United Kingdom, United States, Uzbekistan, and Viet Nam. A very high number of high-quality submissions were received from them 273 were accepted for publication in Procedia Computer Science Journal, Elsevier.

All the submitted papers in Procedia Computer Science have been peer-reviewed by the three reviewers drawn from the scientific committee, external reviewers, and editorial board depending on the subject matter of the paper. Reviewing and initial selection were undertaken electronically.

The International Conference on Machine Learning and Data Engineering was held at the School of Computer Science, University of Petroleum & Energy Studies, India in association with the University of Dayton, Ohio, USA, from 7th to 8th September 2022. The conference was sponsored by SERB, Department of Science and Technology, Government of India.

We would like to acknowledge all the members of the Honorary Advisory chairs, General chairs, Program chairs, Scientific Chairs, Organization committee members, Keynote speakers, the members of the technical committees, and reviewers for their work.

We would like to express our gratitude to the management, Sunil Rai-Vice Chancellor, Ram Sharma-Pro- Vice Chancellor, Manish Madan- Registrar, Deans, Cluster Heads, faculty members, and technical staff for their kind support during the organization of this conference. We would like to thank all the authors, presenters, and delegates for their valuable contributions to making this an extraordinary event.

Finally, we thank Elsevier for their high support and help.